



# Power MOSFETS

## DATASHEET

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**LM40018NHM8A**

N-Channel  
Enhancement Mode MOSFET



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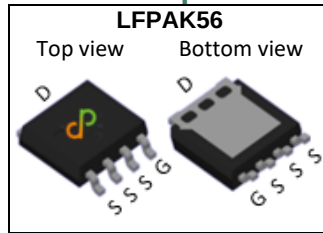


Quality Management Systems

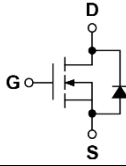
ISO 9001:2015 Certificate

## N-Channel Enhancement Mode MOSFET

### Pin Description



### Symbol



### Product Summary

| Symbol           | N-Channel | Unit       |
|------------------|-----------|------------|
| $V_{DS}$         | 45        | V          |
| $R_{DS(ON)-Max}$ | 2.4       | m $\Omega$ |
| $I_D$            | 120       | A          |

### Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested
- Moisture Sensitivity Level MSL1

### Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

### Ordering Information

| Orderable Part Number | Package Type | Form        | Shipping           | Marking         |
|-----------------------|--------------|-------------|--------------------|-----------------|
| LM40018NHM8A          | LFPAK56      | Tape & Reel | 4000 / Tape & Reel | 40018<br>□□□□□□ |

Note : □□□□□□ = Lot Code

### Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

| Symbol       | Parameter                        | N-Channel               | Unit             |
|--------------|----------------------------------|-------------------------|------------------|
| $V_{DS}$     | Drain-Source Voltage             | 45                      | V                |
| $V_{GS}$     | Gate-Source Voltage              | $\pm 20$                |                  |
| $T_J$        | Maximum Junction Temperature     | 175                     | $^\circ\text{C}$ |
| $T_{STG}$    | Storage Temperature Range        | -55 to 175              |                  |
| $I_S$        | Diode Continuous Forward Current | $T_C=25^\circ\text{C}$  | A                |
| $I_{SP}$     | Diode Pulse Current              | $T_C=25^\circ\text{C}$  |                  |
| $I_{DM}$     | Pulse Drain Current Tested       | $T_C=25^\circ\text{C}$  | 299 <sup>①</sup> |
| $I_D$        | Continuous Drain Current         | $T_C=25^\circ\text{C}$  | 120              |
|              |                                  | $T_C=100^\circ\text{C}$ | 85               |
| $P_D$        | Maximum Power Dissipation        | $T_C=25^\circ\text{C}$  | 62.5             |
|              |                                  | $T_C=100^\circ\text{C}$ | 31.25            |
| $I_D$        | Continuous Drain Current         | $T_A=25^\circ\text{C}$  | 26               |
|              |                                  | $T_A=70^\circ\text{C}$  | 22               |
| $P_D$        | Maximum Power Dissipation        | $T_A=25^\circ\text{C}$  | 3.0              |
|              |                                  | $T_A=70^\circ\text{C}$  | 2.1              |
| $I_{AS}^{②}$ | Avalanche Current, Single pulse  | $L=0.1\text{mH}$        | 32               |
|              |                                  | $L=0.5\text{mH}$        | 18               |
| $E_{AS}^{②}$ | Avalanche Energy, Single pulse   | $L=0.1\text{mH}$        | 51               |
|              |                                  | $L=0.5\text{mH}$        | 81               |

### Thermal Characteristics

| Symbol              | Parameter                              | Rating       | Unit |
|---------------------|----------------------------------------|--------------|------|
| $R_{\theta JC}$     | Thermal Resistance-Junction to Case    | Steady State | 2.4  |
| $R_{\theta JA}^{③}$ | Thermal Resistance-Junction to Ambient | Steady State | 50   |

Note ① : Max. current is limited by junction temperature

Note ② : UIS tested and pulse width are limited by maximum junction temperature  $175^\circ\text{C}$

Note ③ : Surface Mounted on  $1\text{in}^2$  FR-4 board with 1oz

**N-Channel Electrical Characteristics** ( $T_J=25^{\circ}\text{C}$  Unless Otherwise Noted)

| Symbol                               | Parameter                                  | Test Conditions                                                 | Min. | Typ. | Max. | Unit |
|--------------------------------------|--------------------------------------------|-----------------------------------------------------------------|------|------|------|------|
| Static Electrical Characteristics    |                                            |                                                                 |      |      |      |      |
| BV <sub>DSS</sub>                    | Drain-Source Breakdown Voltage             | V <sub>GS</sub> =0V, I <sub>DS</sub> =250uA                     | 45   | -    | -    | V    |
| BV <sub>DSS</sub>                    | Drain-Source Breakdown Voltage (transient) | V <sub>GS</sub> =0V, I <sub>DS</sub> (aval)=32 A, time < 100 us | 48   | -    | -    | V    |
| I <sub>DSS</sub>                     | Zero Gate Voltage Drain Current            | V <sub>DS</sub> =36V, V <sub>GS</sub> =0V                       | -    | -    | 1    | uA   |
| V <sub>GS(th)</sub>                  | Gate Threshold Voltage                     | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250uA       | 2    | 3    | 4    | V    |
| I <sub>GSS</sub>                     | Gate Leakage Current                       | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                      | -    | -    | ±100 | nA   |
| R <sub>DS(ON)</sub> <sup>④</sup>     | Drain-Source On-state Resistance           | V <sub>GS</sub> =10V, I <sub>DS</sub> =40A                      | -    | 2    | 2.4  | mΩ   |
| gfs                                  | Forward Transconductance                   | V <sub>DS</sub> =5V, I <sub>DS</sub> =10A                       | -    | 46   | -    | S    |
| Dynamic Characteristics <sup>⑤</sup> |                                            |                                                                 |      |      |      |      |
| R <sub>G</sub>                       | Gate Resistance                            | V <sub>GS</sub> =0V,V <sub>DS</sub> =0V, Freq.=1MHz             | -    | 1.1  | -    | Ω    |
| C <sub>iss</sub>                     | Input Capacitance                          | V <sub>GS</sub> =0V, V <sub>DS</sub> =20V, Freq.=1MHz           | -    | 2163 | -    | pF   |
| C <sub>oss</sub>                     | Output Capacitance                         |                                                                 | -    | 690  | -    |      |
| C <sub>rss</sub>                     | Reverse Transfer Capacitance               |                                                                 | -    | 57   | -    |      |
| td(ON)                               | Turn-on Delay Time                         | V <sub>GS</sub> =10V,V <sub>DS</sub> =20V, Id=1A,RGEN=1Ω        | -    | 14   | -    | nS   |
| tr                                   | Turn-on Rise Time                          |                                                                 | -    | 10   | -    |      |
| td(OFF)                              | Turn-off Delay Time                        |                                                                 | -    | 26   | -    |      |
| tf                                   | Turn-off Fall Time                         |                                                                 | -    | 49   | -    |      |
| Qg                                   | Total Gate Charge                          | V <sub>GS</sub> =10V,V <sub>DS</sub> =20V, Id=20A               | -    | 30   | -    | nC   |
| Qgs                                  | Gate-Source Charge                         |                                                                 | -    | 10   | -    |      |
| Qgd                                  | Gate-Drain Charge                          |                                                                 | -    | 5    | -    |      |
| Source-Drain Characteristics         |                                            |                                                                 |      |      |      |      |
| VSD <sup>④</sup>                     | Diode Forward Voltage                      | ISD=25A, VGS=0V                                                 | -    | 0.8  | 1.1  | V    |
| trr                                  | Reverse Recovery Time                      | IF=10A, VR=20V                                                  | -    | 32   | -    | nS   |
| Qrr                                  | Reverse Recovery Charge                    | dIF/dt=100A/μs                                                  | -    | 22   | -    | nC   |

Note ④ : Pulse test (pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

## N-Channel Typical Characteristics

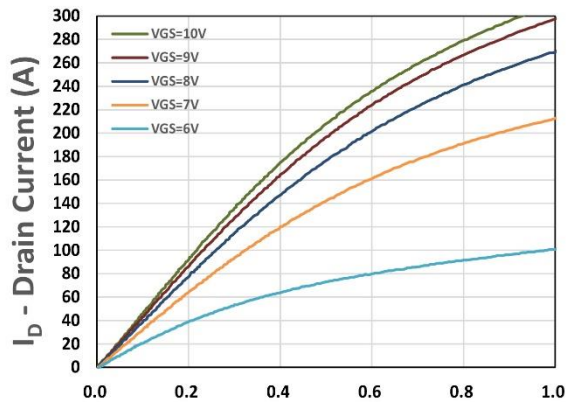


Figure 1. Output Characteristics

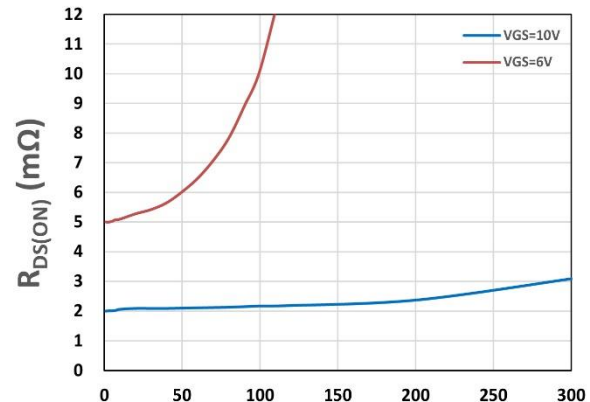


Figure 2. On-Resistance vs.  $I_D$

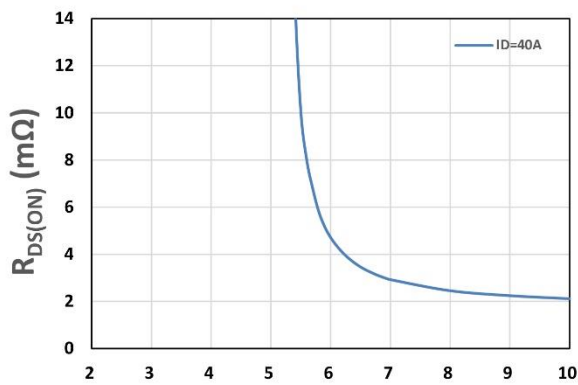


Figure 3. On-Resistance vs.  $V_{GS}$

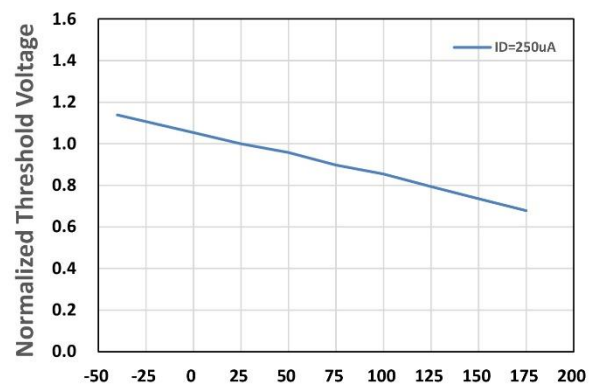


Figure 4. Gate Threshold Voltage

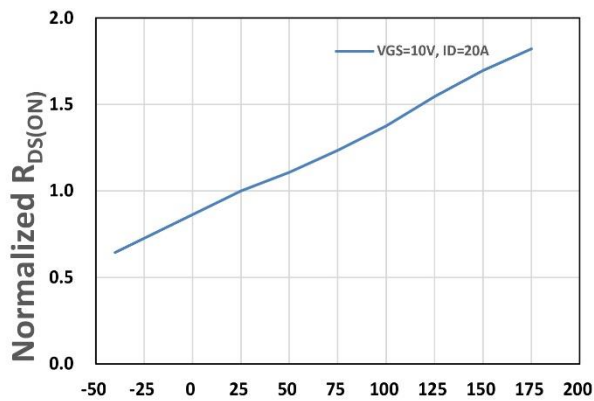


Figure 5. Drain-Source On Resistance

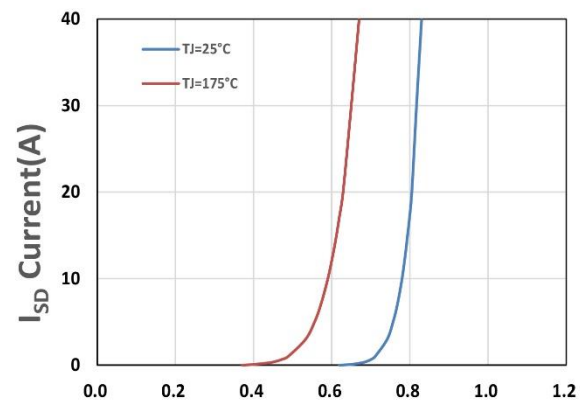


Figure 6. Source-Drain Diode Forward

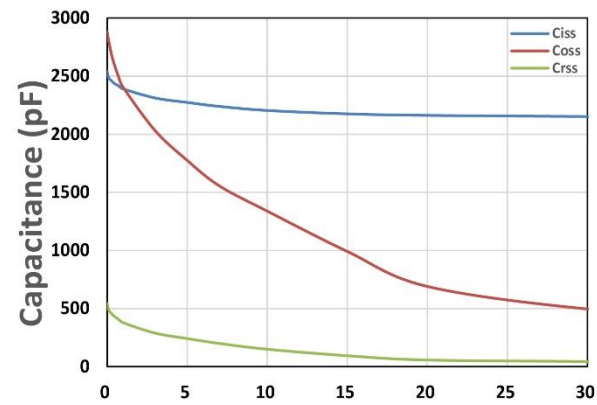


Figure 7. Capacitance

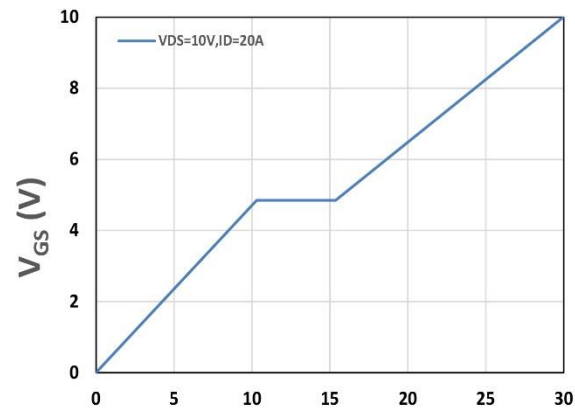


Figure 8. Gate Charge Characteristics

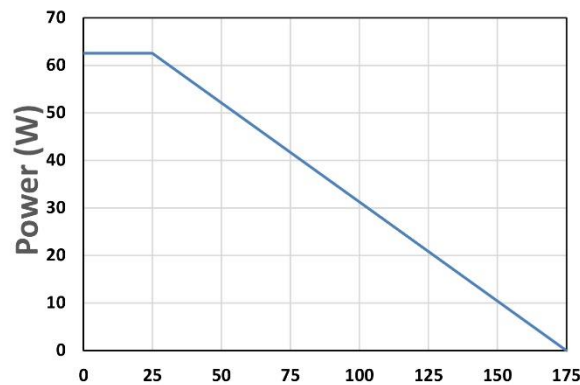


Figure 9. Power Dissipation

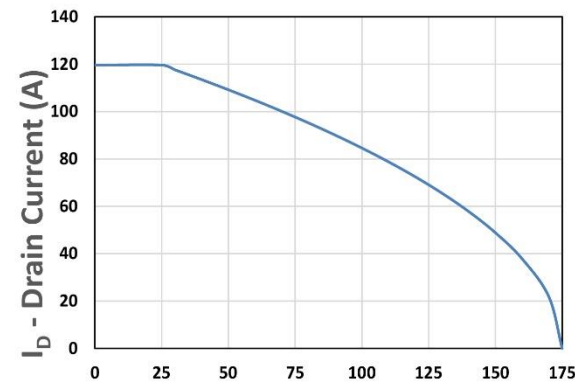


Figure 10. Drain Current

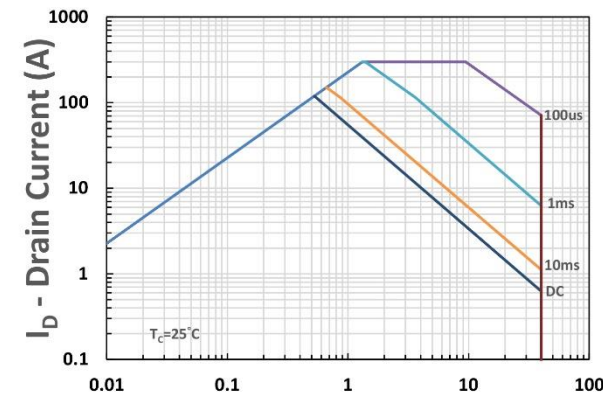


Figure 11. Safe Operating Area

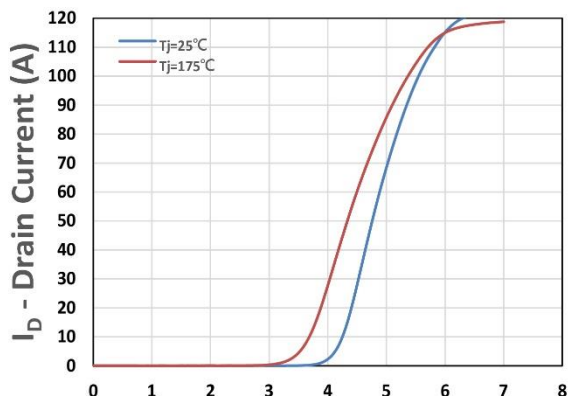


Figure 12. Transfer Characteristics

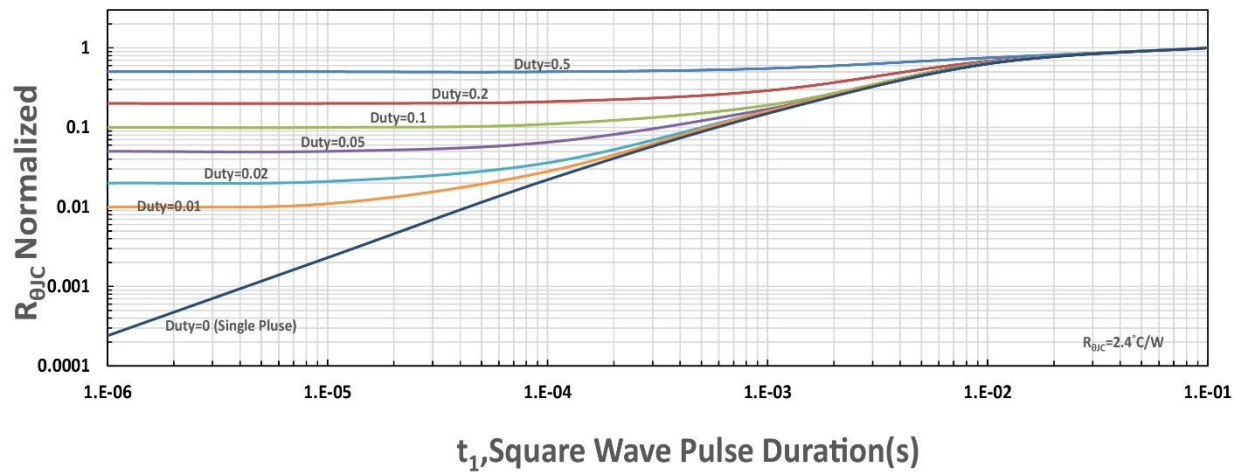


Figure 13.  $R_{\theta JC}$  Transient Thermal Impedance